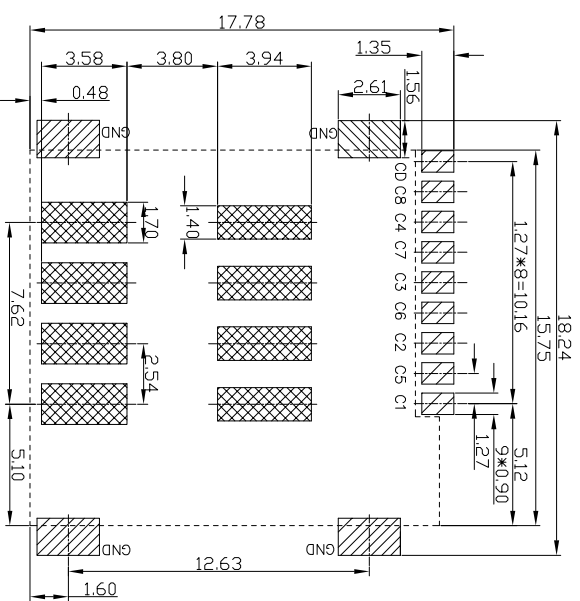


PAD AREA  
 KEEP OUT AREA  
 RECOMMENDED P.C.B LAYOUT  
 COMPONENT SIDE(TOLERANCE ±0.05)



**TECHNICAL CHARACTERISTICS**

**1.General Characteristics**

Dimensions:15.75LX17.17WX1.50H mm

Weight: Approx 0.4±0.1g

Durability:1500 cycles min.

**2.Electrical Characteristics**

Contact resistance:

Date Contact: 150mΩ max

CD Switch: 500mΩ max

Insulation resistance: >1000MΩ/500V DC

**3.Solderability**

Vapor phase: 215°C, 30sec. Max

IR reflow: 250°C, 5sec. Max

Manual soldering: 370°C, 3sec. Max

**4.Environmental Characteristics**

Operating temperature: -40°C~+85°C

Operating humidity: 10%~+95%RH

Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	VPP
C7	I/O
C8	Reserved

ELECTRIC FUNCTION	DETECT SWITCH
WITHOUT CARD	CLOSED
CARD INSERTED	OPEN



ITEM	PART NAME	QTY	MATERIAL	FINISH
1	HOUSING	1	Hi-temp Thermoplastic	Black UL94V-0
2	DATA CONTACT	6	Copper Alloy	Contact area: Gold plated
3	CD SWITCH	1	Copper Alloy	Contact area: Gold plated
4	SHELL	1	Stainless Steel	SMT area: Gold plated
5	COIL SPRING	1	SMP	
6	HEART CAM	1	Hi-temp Thermoplastic	Black UL94V-0
7	CAM PIN	1	Stainless Steel	

**CSSCONN**

CSSCONN PRECISE ELECTRONICS CO.,LTD

PART NO.(INTENDED USE)  
CS108127150004

TITLE: MICRO SIM CARD 8P PUSH 1.5H 外挿式

APPD: SKIla

DWG. NO. SIM CARD

CHKD: Kitty

SCALE SHEET REV

DR: Kitty

1:1 1 OF 1 A